TOSHIBA Photocoupler Photorelay

TLP197GA

PBX

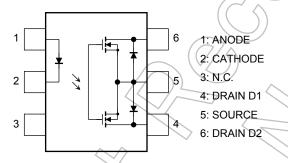
Telecommunication
Modem·FAX Cards, Modems In PC
Measurement Instrumentation

The TOSHIBA TLP197GA consists of an infrared emitting diode optically coupled to a photo-MOSFET in a SOP, which is suitable for surface mount assembly.

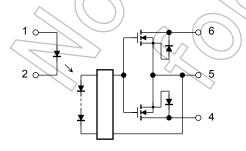
The TLP197GA is suitable for replacement of mechanical relays in many applications which require space savings.

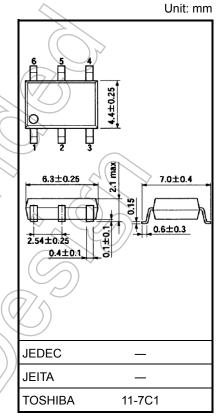
- 6 pin SOP (2.54SOP6): 2.1 mm high, 2.54 mm pitch
- 1-form-A
- Peak off-state voltage: 400 V (min)
- Trigger LED current: 3 mA (max)
- On-state current: 120 mA (max)
- On-state resistance: 35Ω (max)
- Isolation voltage: 1500 Vrms (min)
- UL-recognized: UL 1577, File No.E67349

Pin Configuration (top view)



Schematic





Weight: 0.13 g (typ.)

Start of commercial production 2001-06

Absolute Maximum Ratings (Ta = 25°C)

	Characterist	tics	Symbol	Rating	Unit	
	Forward current		lF	50	mA	
	Forward current derating (Ta ≥ 25°C)		ΔI _F /°C	-0.5	mA/°C	
	Peak forward current (100 μs pulse, 100 pps)		lFP	1	А	
LED	Reverse voltage		VR	5	V	
	Diode power dissi	pation	PD	50	mW	
	Diode power dissipation derating (Ta ≥ 25°C)		ΔP _D /°C	-0.5	mW/°C	(7/5)
	Junction temperat	ure	Tj	125	°C	
	Off-state output terminal voltage		Voff	400	V	
	On-state current	A connection	I _{ON}	120		
		B connection		120	mA(
		C connection		240		
	On-state current derating (Ta ≥ 25°C)	A connection	-	-1.2	mA/°C	
		B connection		-1.2		
ctor		C connection		-2.4		(90)
Detector		A connection		432		
	Output power dissipation	B connection	Po	345	> mW	
		C connection		690		
	Output power	A connection	/	-4.32		$(\vee/)$
	dissipation derating	B connection	ΔP _O / °C <	-3.45	mW7°C	
	(Ta ≥ 25°C)	C connection		-6.9		
	Junction temperature		Tʃ (125	,c/	
Operating temperature range		Topr	−40 to 85	°C	\	
Storage temperature range		Tstg	−55 to 125	°C		
Lead soldering temperature (10 s)		T _{sol}	260	√/°C		
Isolation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 1)		/BV _S	1500	Vrms		

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two-terminal device: LED side pins shorted together, and DETECTOR side pins shorted together.

Recommended Operating Conditions

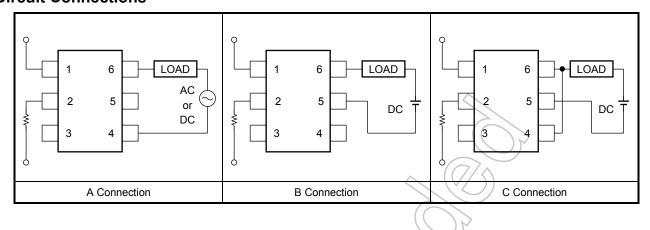
Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	VDD	_	_	320	V
Forward current	lF	5	7.5	25	mA
On-state current	Ion	_	_	120	mA
Operating temperature	Topr	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

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Circuit Connections





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TLP197GA



Individual Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I _R	V _R = 5 V	_	_	10	μА
	Capacitance	Ст	VF = 0 V, f = 1 MHz	/	30	_	pF
ctor	Off-state current	loff	V _{OFF} = 400 V		_	1	μА
Detector	Capacitance	Coff	V = 0 V, f = 1 MHz		70	_	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current		lfT	ION = 120 mA		$\sqrt{(1)}$	3	mA
Return LED current		IFC	IOFF = 100 μA	0.1	1	_	mA
	A connection		ION = 120 mA, IF = 5 mA	+())17	35	
On-state resistance	B connection	Ron	ION = 120 mA, IF = 5 mA	1	(11)/	20	Ω
	C connection		ION = 240 mA, IF = 5 mA	7_	6	_	

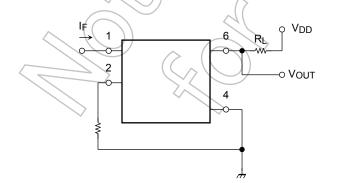
Isolation Characteristics (Ta = 25°C)

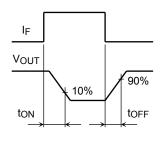
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	V _S = 0 V, f = 1 MHz	_	8.0	_	pF
Isolation resistance	Rs	V _S = 500 V, R.H. ≤ 60 %	5 × 10 ¹⁰	10 ¹⁴	_	Ω
Isolation voltage	BVs	AC, 60 s	1500	_	_	Vrms

Switching Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	ton RL = 20	Ω (Note 2)	_	0.3	1	ms
Turn-off time	toff VDD = 2	0 V, I _F = 5 mA	_	0.1	1	ms

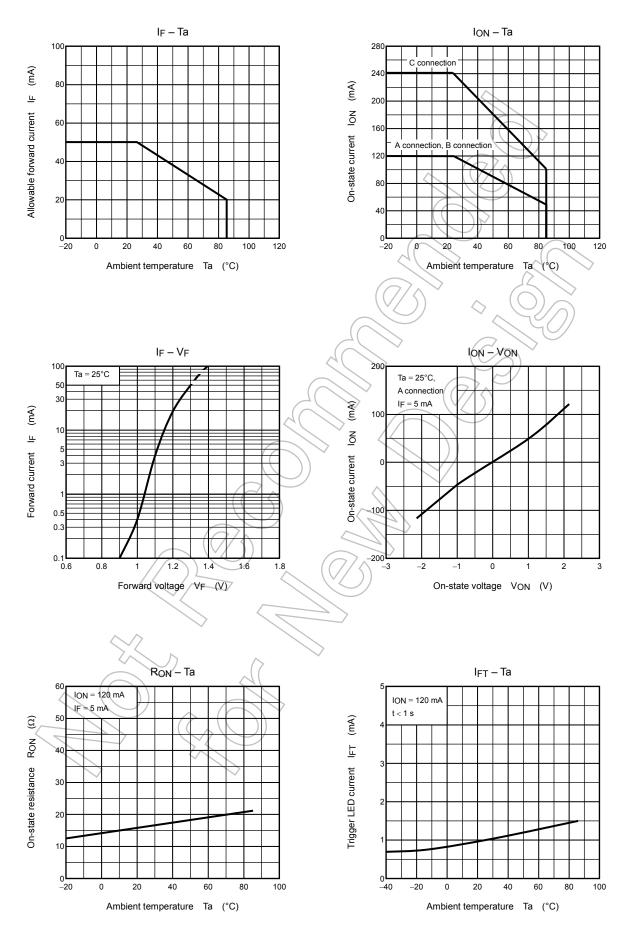
Note 2: Switching time test circuit



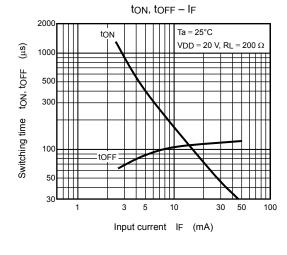


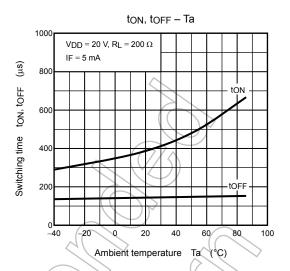
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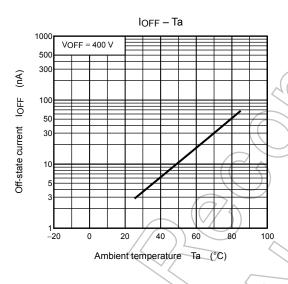
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NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.







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